

B03: HL-LHC CMS Upgrade QA/QC Plan

Carol Wilkinson, Associate Project Manager CD1 Review October 23rd, 2019





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 - QA/QC Components
 - QA Plan Key Elements
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Subproject QA/QC Activities

- QAP Appendix
- QA Activity spreadsheets: Technical flowdown and summary of QA/QC
- Subcomponent QA Plans and Procedures
- QA Activities cost and schedule
- Response to Previous Reviews
 - (Includes 2018 IPR Recommendations and 2019 DR Recommendations)
 - Section 7: Participating Institutions
- Summary



- T.J. Sarlina: CMS Upgrade QA Coordinator
 - Fermilab Quality Assurance Manager and Specialist; IERC and CMS US HL-LHC QA Coordinator (2014-present)
 - Associate Project Manager for ESH and QA for NOvA (2010-2014)
 - Project Manager at Fuel Tech, Inc. for Air Pollution Control Projects (2008-2010)
 - Fermilab Project Scheduler CDF Upgrade Project, DO Upgrade Project, Minerva, Dark Energy Camera (2002-2008)
 - Assistant Radiation Safety Officer for Meson Department (1979-1982)
 - Fermilab Senior Safety Officer for Research Division and Particle Physics Division (1982-2002)
 - Carol Wilkinson CMS Upgrade Associate Project Manager
 - Consultant with 25+ years management experience with DOE and NSF large facilities (2016-present)
 - Visiting Facility Advisor with NSF Large Facilities Office (2013-2016)
 - Advanced LIGO Project Manager (2003 2013)
 - Los Alamos Project Manager Nuclear Weapons Hydrotesting Program (2002 2003)
 - Los Alamos Project Manager and Group Leader DAHRT Accelerator Operations and Facility Construction (1999-2002); Deputy (1998-1999)
 - Los Alamos LAMPF Team Leader Beam Line and Accelerator Physics (1989-1998)



Quality Assurance for U.S. CMS deliverables ensures that the CMS experiment achieves its science requirements and goals.

(listed in the document Science Requirements for U.S. CMS HL-LHC, CMS-doc-13337)

Major components of the U.S. CMS QA Program are:

- Quality Assurance Plan (<u>CMS-doc-13093</u>)
- Subproject (L2) Quality Assurance Plans in QAP Appendix
- Subproject (L2) QA/QC Activities Spreadsheets with ties to requirements and detailed procedures
- Resource-loaded activities in P6 schedule
- Experienced, dedicated, and pro-active technical leads
- Assigned FNAL QA Coordinator for U.S. CMS effort
- Oversight by CERN, CMS, and U.S. CMS management



Quality Assurance Plan (QAP)



CMS-doc-13093

Appendix Revision 5 October 8, 2019

CMS-doc-13093

QAP Appendix contains detailed QA implementation for each L2 subproject

Key Elements

- Applies to both NSF and DOE funded activities
- Describes the QA requirements and processes for international CMS and CERN oversight as well as U.S. CMS oversight.
- Describes responsibilities for each U.S. participating institution for the day-to-day QA/QC practices relevant to its work.
- Controlled document approved & signed by U.S. CMS PM, Deputy PM, and QA Coordinator
- Appendix provides specific detail allowing for differences in sub-project deliverables and organization.



- CERN has a formal review and approval process for all LHC experiments
 - Large Hadron Collider Committee/Upgrade Cost Group (LHCC/UCG) have final approval
 - Overall responsibility for CMS QA is held by the international CMS collaboration.
 - The CMS Technical Coordinator Austin Ball, appointed by CERN, holds overall responsibility for all CMS activities.







Highlights of the international CMS review & approval

- Determination of technical requirements
- Standard technical or engineering design reviews, procurement readiness reviews, etc. during R&D and pre-production
- Compliant with all relevant codes and standards
- Approvals of QA activities, readiness reviews, and acceptance reviews during production and installation
- Approvals are scheduled at four steps of the project (Like Critical Decisions):
 - Step 1 Initial Design (Technical proposal)
 - Step 2 Baseline Design (Detailed Technical Design)
 - Step 3 Final Design / Construction Readiness
 - Step 4 Project Completion/Operations Readiness

The formal approval process is described in the LHC Experiments Phase II Upgrades Approval Process [CERN LHCC-2015-007]



QAP Section 5: CERN/CMS Oversight Roles / Responsibilities

- CERN LHCC/UCG
 - Approve plans for QA as part of Step 2 baseline design approval and at Step 3 for detailed implementation approval.
- CMS Upgrade Coordination Lead
 - Calls for and conducts the CMS internal reviews leading to Step 2
 - Works with the CMS TC for reviews leading to Step 3.
- CMS Upgrade Technical Coordinator (UTC) and Electronics Coordination (UEC) Leads
 - Keep up-to-date drawings and ensure inter-compatibility between CMS subcomponents and LHC infrastructure.
 - Participate in planning/coordination of QA activities and metrics.
 - Call for reviews of all subprojects leading to Step 3
 - Maintain technical documentation in the CMS EDMS or DocDB document systems, including specifications and QA procedures.



- CMS Subdetector Upgrade Coordinators
 - Oversight and management of each integrated detector subsystem, including efforts from all contributors.
- CMS Subdetector QA Managers (assigned by CMS)
 - Coordinate of QA processes across all participating institutions for that subdetector.
 - Responsible for defining or approving assembly/test procedures for each component or subassembly
 - Maintain common data-base and tracking tools for grading, performance matching, and history tracking



U.S. CMS Roles in CMS HL-LHC Upgrade Project

CMS Upgrade Organization

U.S. Upgrade Organization



- QA procedures for each CMS subdetector (e.g. L1 Trigger) established by relevant CMS Subdetector Upgrade Coordinator
- Corresponding U.S. CMS subproject L2 manager (e.g. 402.6) responsible for implementation, documentation, etc. within U.S. project to satisfy CMS requirements and U.S. project/DOE requisites
- Facilitated by the integration of U.S CMS with CMS management
 - Trigger/DAQ Example Shown: CMS Subdetector Upgrade Coordinator is the U.S. CMS L2 manager



- Project Manager (and deputies)
 - Ultimate QA responsibility for U.S. scope
- Project Scientist
 - Supports planning and provide review of the Quality Tests and Inspections developed by the WBS Level 2, 3, & 4 managers/leads
 - Works with Subproject Leads and QA Coordinator to ensure technical requirements are met
- Subproject Leads (WBS L2, L3, L4)
 - Responsible for QA/QC for their scope of work
- QA Coordinator
 - Provides planning support & review/surveillance of participating institution QA procedures
 QA Finding 2
 - Can draw on additional FNAL ESH&Q staff as needed
- QA contact at participating institutions
 - Responsible for QA/QC for their scope of work and communication with Subproject leads
 QA Finding 2



- Details the U.S. QA efforts
 - Personnel Qualifications and Training
 - CMS Requirements and Quality Validation
 - Design & Production Work Processes and Controls
 - Software Quality Assurance Guidelines
 - Procurements (In line with institutional requirements)
 - Acceptance Inspection and Testing
 - Shipping Requirements
 - Issue Tracking via Fermilab iTrack program
 - Documents and Records
 - Technical and Management Assessments
 - Control of Suspect/Counterfeit Items (S/CI)
 - Lessons Learned



- The QAP appendix contains high level descriptions of QA implementation specific to each L2 U.S. CMS subproject, including:
 - Short description of the types of deliverables (designs, hardware, software, test results, etc.)
 - Subdetector organization and communication methods within CMS and U.S. CMS
 - Short over-view of the types of QA activities (electronic prototyping, simulations or other modeling, material testing, procurement, assembly, QC, performance testing, etc.)
 - List of participating institutions
 - Management of non-conforming parts
 - Document and Record keeping

Subproject QA/QC Activity Spreadsheets

- Summary of QA/QC Activities by subproject, including acceptance tests to verify that deliverables meet design performance specifications.
 - Activity titles and descriptions
 - Assigned responsibilities/contacts
 - Flowdown links to technical engineering and/or scientific requirements
 - References to related QA/QC procedures, hardware, training, calibrations
 - Working documents expected to evolve and mature with design efforts

QA Activity Sheets posted with subproject Requirements Documents: Outer Tracker Forward Pixels <u>CMS-doc-13388</u> Endcap Calorimeter <u>CMS-doc-13447</u> Trigger/DAQ <u>CMS-doc-13318</u> MIP Timing Layer <u>CMS-doc-13536</u>



- Endcap Calorimeter
 - WBS, Responsibilities and contacts, QA Activity IDs and titles, and technical requirement references

| <u>WBS</u> | <u>WBS Title</u> | <u>L2, L3, L4 Lead</u> | QA/QC Activity Name | <u>Responsible</u> Institution | QA/QC Coordinator/ Contact | QA/QC Activity ID | Quality Control or Assurance Activity/ Parameter | Specification(s) | <u>Requirement ID</u> | <u>Requirement Title</u> |
|-----------------|------------------|----------------------------|-----------------------|-----------------------------------|----------------------------------|-------------------|--|---|---|--|
| 402.04.03 | Sensors | N. Akchurin, R. Yohay | Neutron Irradiation | Brown, TTU | Hinton | CE-QA-006 | Measurement | [sensor supplier (or CERN) spec dwg/doc numbers assuming that after rad test sensors must still meet spec] | CE-engr-021 | CE sensor radiation hardness |
| 402.04.03 | Sensors | N. Akchurin, R. Yohay | Proton Irradiation | FNAL | R. Yohay | CE-QA-007 | Measurement | [sensor supplier (or CERN) spec dwg/doc numbers assuming that after rad test sensors must still meet spec] | CE-engr-021 | CE sensor radiation hardness |
| 402.04.04.04-06 | Module Assembly | N. Akchurin, M. Paulini | Visual Inspection | UCSB/TTU/CMU | L3s | CE-QC-008 | Monitoring | multiple engineering specification drawings and documents | CE-engr-006 | CE System Integration and Maintainability |
| 402.04.04.01.03 | Module PCB | M. Paulini, K. Kaadze | Acceptance Testing | KSU | K. Kaadze | CE-QC-009 | Measurement | [PCBs dwg/doc numbers] | CE-engr-027, CE-engr- 028, CE-engr-041 | CE silicon module PCB features has to match those of the silicon sensor within tolerance; CE silicon module PCB wirebonding pads; silicon module able to operate at -30C and tolerate thermal cycling. |
| 402.04.04-06 | Module Assembly | N. Akchurin, M. Paulini | Acceptance Testing | UCSB/TTU/CMU | L3s | CE-QC-010 | Measurement | [module components top dwg/doc numbers] | CE-engr-006 | CE System Integration and Maintainability |
| 402.04.04-06 | Module Assembly | N. Akchurin, M. Paulini | Standardized Assembly | UCSB | J. Incandela, S. Gyre | CE-QA-011 | Process Control | multiple engineering specification drawings and documents | CE-engr-006 | CE System Integration and Maintainability |
| 402.04.04-06 | Module Assembly | N. Akchurin, M. Paulini | Acceptance Testing | UCSB/TTU/CMU | L3s | CE-QC-012 | Measurement | [module top dwg/doc numbers] | CE-engr-041, CE-engr- 045,CE-engr-048 | silicon module able to operate at -30C and tolerate thermal cycling; Robust sensor connections and HV standoff, Alignment precision for the module layers is 25 microns |

Sample QA/QC Activity Spreadsheet (2)

EndCap Calorimeter (cont.)

QA/QC process descriptions, procedures, calibrations, records, training

| QA/QC Activity Name | QA/QC Activity ID | <u>(QA)</u> <u>Validation Activities</u> | (<u>QC)</u> Inspection / Acceptance Tests | Measurement/ Method | Associated Hardware/ Software | <u>Standard / Procedure /</u> <u>Process Doc</u> | Calibration Planning | <u>Record (Data,</u> Calibration, etc.) | Training and Qualifications |
|-----------------------|-------------------|---|---|---|---|---|---|--|---|
| Neutron Irradiation | CE-QA-006 | Sample of sensors irradiated with neutrons to verify radiation tolerance | NA | Neutron Irradiation and evaluation is carried out on a subset of sensors per batch to ensure radiation tolerance throughout production | Access to RINSC, post- irradiation Sensor/Process QC tests | [neutron rad test procedure doc number] | Neutron Flux and Energy spectrum calibrated periodically | Test results stored in database, available through etraveler | Irradiation done professionally, evaluation as above |
| Proton Irradiation | CE-QA-007 | Sample of sensors irradiated with protons to verify radiation tolerance | NA | Proton Irradiation and evaluation is carried out on a subset of sensors per batch to ensure radiation tolerance throughout production | FSU linac, FNAL ITA, post-irradiation testing | [Proton rad test procedure document number] | N/A | Test results stored in database, available through etraveler | Irradiation done professionally, evaluation as above |
| Visual Inspection | CE-QC-008 | NA | Visual inspection of mechanical and electrical components before use in assembly | All components will be visually inspected at the Assembly Sites before entering the assembly chain | Microscope | https://twiki.cern.ch/t wiki/bin/view/CMS/HG CALModuleTesting | N/A | Visual inspection results stored in database, available in etraveler | Short learning period to be able to identify substandard fabrication (discoloration, poor traces, etc.) |
| Acceptance Testing | CE-QC-009 | NA | Electrical testing and thermal cycling of readout PCBs before integration into modules; Validation of PCB functionality before module assembly including thermal cycling and burn-in | PCBs will be tested at a common point using standard test systems before shipment to module assembly sites. Test will include thermal cycling of the PCBs, visual inspection, etc. | Module test system, thermal cycling system | https://twiki.cern.ch/t wiki/bin/view/CMS/HG CALModuleTesting | i. N/A | Test results stored in database, available through etraveler | No special skills but training required on test systems |
| Acceptance Testing | CE-QC-010 | NA | Verification of component functionality before integration into Modules: | Components will be acceptance tested at the Assembly Sites before entering the assembly chain | Component test systems | <u>https://twiki.cern.ch/t</u> wiki/bin/view/CMS/HG CALModuleTesting | Standard-candle components will be used to verify testing capabilities | Test results stored in database, available through etraveler | No special skills but training required on test systems |
| Standardized Assembly | CE-QA-011 | Assembly at different sites will follow identical procedures | NA | Fully specified and documented Assembly procedures followed at all sites, identical tooling sets used for module assembly, cross-site calibrations | N/A | https://twiki.cern.ch/t wiki/bin/view/CMS/HG CALModuleAssembly | N/A | Official procedures will be under document control | Clearly assembly requires skilled technicians |
| Acceptance Testing | CE-QC-012 | NA | Validation of module dimensions, features, functionality, and robustness before shipping to cassette assembly site. | Modules will be acceptance tested and graded at the Assembly Sites before shipping to the cassette assembly site. Visual inspection, OGP measurements of the module features, thickness, and flatness, and functionality testing with a standard module test stand. Tests will be done both before and after thermal cycling and burn-in. | OGP, Module test system, thermal cycling system. | https://twiki.cern.ch/t wiki/bin/view/CMS/HG CALModuleTesting, example from previous project is Phase 1 FPIX module testing procedures CMS-DocDB-12690 | N/A | Test results stored in database, available through etraveler | QC work requires technician trained in use of existing testing systems |



Subcomponent QA/QC Plans and Procedures

- Detailed QA/QC plans, procedures, and acceptance tests and processes
 - Many based on previous work: initial construction, phase 1 upgrades, or HL-LHC upgrade prototyping
 - Some provided to U.S. CMS by the CMS collaboration
 - All U.S. plans written in collaboration with or approved by CMS
 - Finalized as design efforts and production planning mature

| CMS HL-LHC DocDB Project Document No. | | This page will contain documentation for testing | High-Granularity Calorimeter (HGCal) modules and components | PCB application | | |
|--|---|--|--|---|--|--|
| | Trigger and DAQ System QA/QC Te Plan | If you have questions that aren't covered here, p there, feel free to post it in the <u>Q&A</u> page (if it's n | lease check the \underline{FAQ} page. If your question is not answered not already there.) | To place the PCB, we now set the height of the tool to the thickness of the PCB+the glue layer between the sensor+ the sensor & kapton baseplate. We can do th again by using the cera gauge blocks as shown below. | | |
| QA/QC TEST PLAN DOCUMENT | Page 1 Revision: B Date: 07-October-2 | Page Contents | | | | |
| Trigger and DAQ (| WBS 402.06 and | Baseplate-kapton leakage PCB testing Module testing | HGCAL Module | | | |
| NOTE The most recent DocDB versio ONLY controlled record Refer to CMS-d This document is only to be revised by the | co-13318 Trigger and DAQ (WBS 402.06 and | Burn-in Themal testing Themal cycling | Assembly dresting | Wire Bonding Assembly | | |
| 402.09) Manager or Sy Abstract The purpose of this document is to describe how the it meets its design and functional requirements. | stems Engineer | Baseplate-kapton leakage PCB testing | | &Testing | | |
| Prepared by: Checked I Richard Cavanaugh J. Dolph | y: Approved by: J. Berryhill K. Ulmer | Module testing Standard IV curve and DAQ | | Wirebonding Wire bonding connects the layers of the module electronically with wires. The basic steps to wire bonding are: | | |
| L2 Systems Engineer(s) Lead Systems Engineer L2 Manager(s) Revision status recorded in: CMS-doc-13318 | | Burn-in | | Pre-bonding Inspection: A brief microscopic review of the module after the gluing step looking for issues with bond pads, glue spillage, or PCB damage. Test Bonds: During any production, each module is a candidate for oreating test bonds and evaluating their strength with the pull tester. During full production, every 10th module will undergo this step. After pull testing all test wires are removed. Wirebonding Program Run: Execution of the wirebond program by the machine. Troubleshot as needed if the machine encounters an error and stops. Post-bonding Inspection: A microscopic review of all wire bonds. Any missed bonds will need to be corrected. | | |
| | | Thermal testing | | Orum Region, Tealisming of instance with a low an instance in regional or ophilded withins, and initials of the user. Occumentation: Each of these taps is longed in the database with time, date, and initials of the user. Current standard operating procedures from Summer 2019: Run Wirebond Program checklist Run_Wirebond_Program_twiki_version.docx | | |
| | | BrunelConstantineOdegard - 2019-02-26 | | Pul testing checklist Pul_Testing_twiki_version.docx | | |

Samples of existing QA/QC plans

QA/QC Activities Cost and Schedule

- QA/QC activities are integrated into the Resource Loaded Schedule (RLS)
 - Schedule activities: Readiness reviews, prototyping, materials testing, acceptance QA/QC, performance testing, acceptance reviews, etc.
 - P6 schedule (RLS) includes cost and labor for QA activities
- highlighted

QA/QC activities

402.2 - Outer Tracker Example - 2S Module Production – Batch 01

| Activity Name | | Duration | Start | Finish | FNAL | Univ | FNAL Labor | Univ Labor | Material | Resp | | ▲ FY2022 FY2023 |
|--------------------------------|--|----------|-----------|-----------|------|------|------------|------------|----------|-------|---|---|
| | | | v | | Hrs | Hrs | Cost | Cost | Cost | Inst. | | F F F F F F F F F F F F F F F F F F F |
| Inspect sensors for 25 ptrau | ction modules (Brown) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 0 | 35 | \$0 | \$984 | \$0 | BR | | Inspect sensors for 25 production modules (Brown) - Batch 01 |
| Inspect mechanical component | ents for 2S production modules (Brown) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 0 | 24 | \$0 | \$675 | \$0 | BR | | Inspect mechanical components for 2S production modules (Brown) - Batch 0 |
| Inspect mechanical component | ents for 2S production modules (FNAL) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 24 | 0 | \$0 | \$0 | \$0 | FN | | Inspect mechanical components for 2S production modules (FNAL) - Batch 01 |
| Inspect Hybrids for 2S produ | ction modules (Brown) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 0 | 21 | \$0 | \$1,434 | \$0 | BR | | Inspect Hybrids for 2\$ production modules (Brown) - Batch 01 |
| T4 - Start assembly of 2S pro | duction modules | Od | 22-Feb-22 | | 0 | 0 | \$0 | \$0 | \$0 | | | T4 - Start assembly of 2S production modules |
| Inspect Hybrids for 2S produ | ction modules (FNAL) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 21 | 0 | \$1,588 | \$0 | \$0 | FN | | Inspect Hybrids for 2\$ production modules (FNAL) - Batch 01 |
| Inspect sensors for 2S produ | ction modules (FNAL) - Batch 01 | 50d | 22-Feb-22 | 02-May-22 | 35 | 0 | \$0 | \$0 | \$0 | FN | | Inspect sensors for 2\$ production modules (FNAL) - Batch 01 |
| Test hybrids for 2S productio | n modules (Brown) - Batch 01 Labor | 50d | 01-Mar-22 | 09-May-22 | 0 | 132 | \$0 | \$5,546 | \$0 | BR | | Test hybrids for 2S production modules (Brown) - Batch 01 Labor |
| Test hybrids for 2S productio | n modules (FNAL) - Batch 01 Labor | 50d | 01-Mar-22 | 09-May-22 | 32 | 0 | \$3,816 | \$0 | \$0 | FN | | Test hybrids for 2S production modules (FNAL) - Batch 01 Labor |
| Perform mechanical assembl | y of 2S production modules (Brown) - Batch 01 MS | 50d | 08-Mar-22 | 16-May-22 | 0 | 0 | \$0 | \$0 | \$3,001 | BR | | Perform mechanical assembly of 2S production modules (Brown) - Batch 01 MS |
| Perform mechanical assembl | y of 2S production modules (FNAL) - Batch 01 MS | 50d | 08-Mar-22 | 16-May-22 | 0 | 0 | \$0 | \$0 | \$1,895 | FN | | Perform mechanical assembly of 2S production modules (FNAL) - Batch 01 MS |
| Perform mechanical assembl | y of 2S production modules (Brown) - Batch 01 Labor | 50d | 08-Mar-22 | 16-May-22 | 0 | 682 | \$0 | \$44,832 | \$0 | BR | | Perform mechanical assembly of 2S production modules (Brown) - Batch 01 Labor |
| Perform mechanical assembl | y of 2S production modules (FNAL) - Batch 01 Labor | 50d | 08-Mar-22 | 16-May-22 | 462 | 0 | \$51,493 | \$0 | \$0 | FN | | Perform mechanical assembly of 2S production modules (FNAL) - Batch 01 Labor |
| Track and ship 2S productio | n modules (Brown) - Batch 01 MS | 50d | 29-Mar-22 | 07-Jun-22 | 0 | 0 | \$0 | \$0 | \$3,864 | BR | | Track and ship 2S production modules (Brown) - Batch 01 MS |
| Track and ship 2S productio | n modules (Brown) - Batch 01 Labor | 50d | 29-Mar-22 | 07-Jun-22 | 0 | 21 | \$0 | \$1,698 | \$0 | BR | | Track and ship 2S production modules (Brown) - Batch 01 Labor |
| Wire bond hybrids for 2S pro | duction modules (FNAL) - Batch 01 Labor | 50d | 05-Apr-22 | 14-Jun-22 | 221 | 0 | \$21,939 | \$0 | \$0 | FN | | Wire bond hybrids for 2S production modules (FNAL) - Batch 01 Labor |
| Fast-test hybrids for 2S produ | iction modules (FNAL) - Batch 01 Labor | 50d | 05-Apr-22 | 14-Jun-22 | 32 | 0 | \$0 | \$0 | \$0 | FN | | Fast-test hybrids for 2S production modules (FNAL) - Batch 01 Labor |
| Encapsulate hybrids for 2S p | roduction modules (FNAL) - Batch 01 Labor | 50d | 05-Apr-22 | 14-Jun-22 | 53 | 0 | \$5,261 | \$0 | \$0 | FN | | Encapsulate hybrids for 2S production modules (FNAL) - Batch 01 Labor |
| Wire bond and encapsulate | hybrids for 2S production modules (FNAL) - Batch 01 MS | 50d | 05-Apr-22 | 14-Jun-22 | 0 | 0 | \$0 | \$0 | \$1,895 | FN | | Wire bond and encapsulate hybrids for 2S production modules (FNAL) Batch 01 MS |
| Wire bond and encapsulate | hybrids for 2S production modules (Rutgers) - Batch 01 MS | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 0 | \$0 | \$0 | \$1,466 | RU | | Wire bond and encapsulate hybrids for 2S production modules (Rutgers) - Batch 01 MS |
| Wire bond and encapsulate | hybrids for 2S production modules (Princeton) - Batch 01 MS | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 0 | \$0 | \$0 | \$1,523 | PU | | Wire bond and encapsulate hybrids for 2S production modules (Princeton) - Batch 01 MS |
| Perform QC tests of 2S produ | iction modules (FNAL) - Batch 01 MS | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 0 | \$0 | \$0 | \$0 | FN | | Perform QC tests of 2S production modules (FNAL) - Batch 01 MS |
| Wire bond and encapsulate | hybrids for 2S production modules (Rutgers) - Batch 01 Labor | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 137 | \$0 | \$11,242 | \$0 | RU | | Wire bond and encapsulate hybrids for 2S production modules (Rutgers) - Batch 01 Labor |
| Perform QC tests of 2S produ | iction modules (FNAL) - Batch 01 Labor | 50d | 12-Apr-22 | 21-Jun-22 | 11 | 0 | \$0 | \$0 | \$0 | FN | | Perform QC tests of 2S production modules (FNAL) - Batch 01 Labor |
| Wire bond and encapsulate | hybrids for 2S production modules (Princeton) - Batch 01 Labor | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 137 | \$0 | \$16,933 | \$0 | PU | | Wire bond and encapsulate hybrids for 2S production modules (Princeton) - Batch 01 Labo |
| Fast-test hybrids for 2S produ | uction modules (Rutgers) - Batch 01 Labor | 50d | 12-Apr-22 | 21-Jun-22 | 0 | 16 | \$0 | \$1,313 | \$0 | RU | | Fast-test hybrids for 2S production modules (Rutgers) - Batch 01 Labor |
| Fast-test hybrids for 2S produ | iction modules (Princeton) - Batch 01 MS | 50d | 19-Apr-22 | 28-Jun-22 | 0 | 0 | \$0 | \$0 | \$0 | PU | | Fast-test hybrids for 2S production modules (Princeton) - Batch 01 MS |
| Perform QC tests of 2S produ | uction modules (Rutgers) - Batch 01 MS | 50d | 19-Apr-22 | 28-Jun-22 | 0 | 0 | \$0 | \$0 | \$0 | RU | | Perform QC tests of 2S production modules (Rutgers) - Batch 01 MS |
| Fast-test hybrids for 2S produ | uction modules (Princeton) - Batch 01 Labor | 50d | 19-Apr-22 | 28-Jun-22 | 0 | 16 | \$0 | \$1,978 | \$0 | PU | | Fast-test hybrids for 2S production modules (Princeton) - Batch 01 Labor |
| Perform QC tests of 2S produ | uction modules (Rutgers) - Batch 01 Labor | 50d | 19-Apr-22 | 28-Jun-22 | 0 | 138 | \$0 | \$3,977 | \$0 | RU | | Perform QC tests of 2S production modules (Rutgers) - Batch 01 Labor |
| Perform QC tests of 2S produ | iction modules (Princeton) - Batch 01 Labor | 50d | 19-Apr-22 | 28-Jun-22 | 0 | 138 | \$0 | \$3,694 | \$0 | PU | | Perform QC (ests of 2S production modules (Princeton) - Batch 01 Labor |
| Track and ship 2S productio | n modules (FNAL) - Batch 01 MS | 50d | 26-Apr-22 | 06-Jul-22 | 0 | 0 | \$0 | \$0 | \$3,672 | FN | | Track and ship 2S production modules (FNAL) - Batch 01 MS |
| Track and ship 2S productio | n modules (FNAL) - Batch 01 Labor | 50d | 26-Apr-22 | 06-Jul-22 | 21 | 0 | \$2,085 | \$0 | \$0 | FN | - | Track and ship 2S production modules (FNAL) - Batch 01 Labor |
| | | | | | | | | | | | | |

Carol Wilkinson | QA/QC Plan -- DOE CD1 Review



2018 IPR: Institutional QA/QC plans, roles, and oversight not clearly defined

- The Quality Assurance (QA) Plan, prepared in May 2018, relies heavily on CMS processes and specifies that each institution will have its own QA plan. The institutional plans were not presented or available for review. QA evaluation and oversight for institutions must be clearly defined and include any CERN qualification steps by defining sequence and prerequisites.
- Similarly, the university/institutional ES&H plan coordination, review, and acceptance/ concurrence process and criteria is not defined. The Integrated Safety Management and QA plans need to clearly define the role of the project in the review and coordination and oversight of institution ES&H and QA plans.

Efforts since the 2018 IPR

- QAP revised
- QAP Section 7 clarifies U.S. QA/QC institutional plans and roles within the CMS framework
- QAP appendices and spreadsheets updated; QA/QC activities linked to requirements
- Held dedicated ESH&Q review <u>Nov. 29, 2018</u> to ensure that we addressed concerns

QA Finding 1

QA Finding 2



2018 ESH&Q Review: The QAP needs to address the packaging and shipping requirements for components to be sent to CERN.

Added Section 6.10 on Shipping Requirements to the QAP

2019 DR: ESH&Q aspects have been addressedThe QAP is thorough and ready for CD-1



QAP Section 7: QA Oversight for Participating Organizations

Charge 8

All participating U.S. CMS institutions must follow QA plans that satisfy CMS Subdetector requirements and the QAP.

- QA plans and procedures created collaboratively QA Finding 1
 - U.S. L2, L3, L4 leads work with institutional technical and QA representatives and the US CMS QA Coordinator
 - U.S. leads ensure adherence to CMS requirements and approved procedures, subject to CMS review and approval process
 - Includes work under subawards to vendors or other participating institutions.
 - Institution staff responsible for verifying compatibility of QA/QC plans to local institutional QA programs
- L2 lead and the US CMS QA Coordinator review and approve the QA plans and monitor/verify compliance.
 QA Finding 2
 - Most plans are still in development as production readiness advances
 - Site visits may be required for QA plan approval and surveillance

List of Participating Institution Site Audits

Preliminary ESH&Q Site visits have started (Reports <u>CMS-doc-13856</u>)

- UCSB site visit reports for ESH and QA July 2019.
- Fermilab site visit reports for ESH and QA August 2019.
- Rutgers, Princeton, Brown site visit reports for ESH and QA -September 2019.

Charge 8

QA Finding 2

| WBS # | WBS Description | Facilities |
|-----------|---|---|
| 402.02.03 | Outer Tracker: Sensors | Brown, Rochester, Fermilab |
| 402.02.04 | Outer Tracker: Electronics | Fermilab, Princeton, Rutgers |
| 402.02.05 | Outer Tracker: Modules | Brown, Fermilab, Princeton, , Rutgers |
| 402.02.06 | Outer Tracker: Flat Barrel Mechanics | Fermilab |
| 402.02.07 | Outer Tracker: Integration | Fermilab |
| 402.04.03 | Calorimeter Endcap: Sensors | Brown, Fermilab, Texas Tech, FSU |
| 402.04.04 | Calorimeter Endcap: Modules | Carnegie Mellon, Texas Tech, UC Santa Barbara |
| 402.04.05 | Calorimeter Endcap: Cassettes | Fermilab, Minnesota |
| 402.04.06 | Calorimeter Endcap: Scintillator Caorimetry | Fermilab, FSU, Maryland, NIU, Rochester |
| 402.04.07 | Calorimeter Endcap: Electronics and Services | Fermilab, Minnesota |
| 402.06.03 | Trigger / DAQ: Cal Trigger | Wisconsin |
| 402.06.05 | Trigger / DAQ: Correlator Trigger | Wisconsin |
| 402.06.06 | Trigger / DAQ: DAQ | Fermilab |
| 402.08.03 | Timing Layer: Barrel Timing Layer | Virginia, Caltech, KSU |
| 402.08.04 | Timing Layer: Endcap Timing Layer | Fermilab, Nebraska, Kansas |

Carol Wilkinson | QA/QC Plan -- DOE CD1 Review



Site Field Audit Checklist

Charge 8

QA Finding 2

Sample QA Audit Report for UCSB. <u>CMS-doc-13856</u>

US-HL-CMS Quality Assurance Audit Site Visit Checklist WBS 402.4 HGCal Module Group-UCSB Date: 2 July 2019

Contacts: Suzanne Kyre, Dano Pagenkopf, Joe Incandela

Location: UC Santa Barbara

| 1. | Material/Component Receipt and Shipment | Satisfactory | In Progress | No |
|----|--|-------------------|-------------|-----|
| | Have acceptance criteria been defined by the organization? | X | | |
| | Are the criteria written down, approved, and entered into a database? | | Х | |
| | Did the criteria change over time with documentation entered into a database? | | Х | |
| | If changes have occurred, have they been approved by appropriate authority? | X | | |
| | Is data transmitted from last organization in a timely way and is it useful? | X | | |
| | Do written procedures exist and are they followed? | | Х | |
| | Are personnel properly trained to conduct acceptance checks? | X | | |
| | Are the results being documented in a consistent manner? | X | | |
| | Are test results entered into a database or to a traveler? | X | | |
| | Is all measuring and test equipment properly calibrated? | | | Х |
| | Are components stored in secure/segregated locations to prevent damage or loss? | X | | |
| | Have shipping requirements been defined to prevent damage during transport? | X | | |
| 2 | Quarantine of Deficient or Non-Conforming Product | Satisfactory | In Progress | No |
| 2. | Are storage areas properly identified? | Satisfactory X | minugicas | 110 |
| | Is product labeling clearly visible and consistent? | | x | |
| | Have non-conformance procedures been written and approved? | | | Х |
| | | | | |
| 3. | Personnel Training | Satisfactory | In Progress | No |
| | Do current, written procedures exist for each process? | | X | |
| | Do posted instructions agree with authorized, written procedures? | | Х | |
| | Is there a process for informing or re-training workers when procedures change? | X | | |
| | Are procedural changes reviewed for impact on the final product? | X | | |
| | | | | |
| 4. | Acceptance Criteria For Finished Product | Satisfactory | In Progress | No |
| | Have acceptance criteria been defined by the organization? | X | | |
| | Are the criteria written down, approved, and entered into a formal document? | X | | |
| | Have updated acceptance specs been approved and documented? | X | | |
| - | Have storage requirements been defined to prevent damage? | X | | |
| 5. | Records, Logs, and Databases | Satisfactory | In Progress | No |
| | Have standard forms/spreadsheets been created to record data? | X | | |
| | Is information entered in a timely and consistent manner? | X | | |
| | Has the information been entered into a database? | | Х | |
| | 4 | | | |
| | Are paper copies stored in an organized and secure manner? | | | |
| | Are paper copies stored in an organized and secure manner? Are local databases backed up to prevent loss of data in the event of a failure? | X | | Х |

- L2 and U.S. CMS ESH&Q
 Coordinator visit sites to review
 ESH&Q as necessary.
- Site Visit QA Audit Checklist Template <u>CMS-doc-13668</u>

Notes and Observations:

1. Material/Component Receipt and Shipment

- Three main components are received from commercial vendors: the base plates, sensors, and printed circuit boards (PCBs). Visual inspections are performed on all components and the PCBs will be tested electronically at some level. A percentage of baseplates will be checked for flatness against fabrication drawings. CERN database will be the official repository but, for the moment, the CERN DocDB is the current repository as the final database is not yet ready to accept data.
- Mechanical and electrical tests will be performed after fabrication and the acceptable modules will be shipped to either Fermilab or CERN to be assembled into cassettes. Additional tests will be performed at the cassette assembly sites to verify that nothing has been damaged during shipment.
- Procedures are still being developed and refined by the group. Database development is in progress with travelers currently being used to document component properties.
- Finished product acceptance criteria are well understood at this point for items being produced for a specific purpose (not in production phase yet).
- Shipping containers have been designed for the 8-inch modules based on a previous design for the 6 inch modules. A retrofit is necessary to expand the boxes and the design will be shared with the other 5 fabrication sites.

HGCal Module Assembly

Recommendations:

- 1. Schedule the recalibration of the OGP with the manufacturer.
- 2. Determine a single location for procedures that allows for version control so that personnel know where to find the current version if necessary.
- 3. Procedures should be edited to remove vague language and excess narrative. Checklists should be considered to provide clear, step by step instructions and to better highlight danger/caution steps.
- 4. Verify that all computers used for the CMS upgrade project are backed up in a timely and reliable manner.
- 5. Define a central repository for drawings that has version control and require all sites to make use of it.



- Quality Assurance Plan updated and finalized: signed & posted Charge 7
- Capable management team in place
 - QA leads assigned, with defined organization, roles, and responsibilities
- QA policies are established & applied consistently throughout project
 - Quality Assurance controls defined from CERN/CMS through Fermilab to U.S. participating institutions
 - Applied consistently to all participating U.S. efforts (NSF and DOE)
- Documented QA/QC activities to verify that performance is met
 - Activity spreadsheets and procedures (on-going procedure development)
 - Flowdown captured from technical requirements to QA/QC Activities
 - QA/QC activities integrated into RLS (P6) schedule and budget
- All previous review recommendations addressed Charge 8

QA/QC Plan ready for CD-1